



# PESD2CANFD27U-QB

ESD protection for In-vehicle networks

30 September 2020

Product data sheet

## 1. General description

ESD protection device in an ultra small DFN1110D-3 (SOT8015) leadless Surface-Mounted Device (SMD) plastic package with side wettable flanks designed to protect two automotive In-vehicle network bus lines from the damage caused by ElectroStatic discharge (ESD) and other transients.

## 2. Features and benefits

- Reverse stand-off voltage:  $V_{RWM} = 27\text{ V}$
- Low clamping voltage:  $V_{CL} = 34\text{ V}$  at  $I_{PP} = 1\text{ A}$
- ESD protection up to 15 kV (IEC 61000-4-2)
- Ultra low capacitance:  $C_d = 4.0\text{ pF}$
- ESD protection up to 15 kV (ISO 10605;  $C = 150\text{ pF}$ ;  $R = 330\ \Omega$ )
- AEC-Q101 qualified

## 3. Applications

ESD protection for In-vehicle network lines in automotive environments

- CAN-FD
- CAN
- FlexRay
- SENT

## 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$V_{RWM}$	reverse standoff voltage	$T_{amb} = 25\text{ }^\circ\text{C}$		-	-	27	V
$I_{PPM}$	rated peak pulse current	$t_p = 8/20\ \mu\text{s}$	[1] [2]	-	-	1.8	A
$V_{CL}$	clamping voltage	$I_{PPM} = 1\text{ A}$ ; $t_p = 8/20\ \mu\text{s}$ ; $T_{amb} = 25\text{ }^\circ\text{C}$	[3] [2]	-	34	45	V

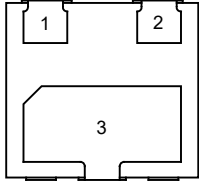
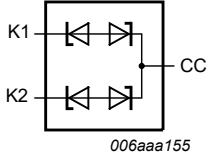
[1] According to IEC 61000-4-5.

[2] Measured from pin 1 or 2 to pin 3.

[3] Device stressed with 8/20  $\mu\text{s}$  exponential decay waveform according to IEC 61000-4-5.

## 5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K1	cathode (diode 1)	 <p>DFN1110D-3 (SOT8015)</p>	 <p>006aaa155</p>
2	K2	cathode (diode 2)		
3	CC	common cathode		

## 6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PESD2CANFD27U-QB	DFN1110D-3	plastic, leadless extremely thin small outline package with side-wettable flanks (SWF); 3 terminals; 0.65 mm pitch; 1.1 mm x 1 mm x 0.48 mm body	SOT8015

## 7. Marking

Table 4. Marking codes

Type number	Marking code
PESD2CANFD27U-QB	C3

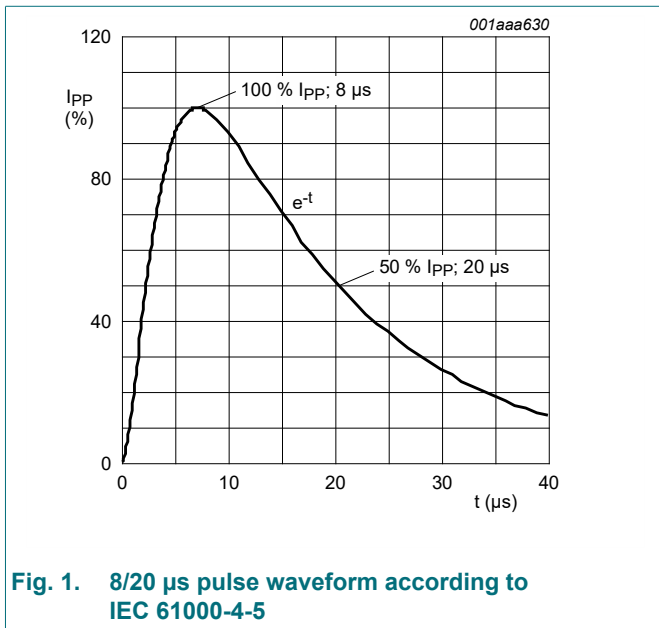
## 8. Limiting values

**Table 5. Limiting values**

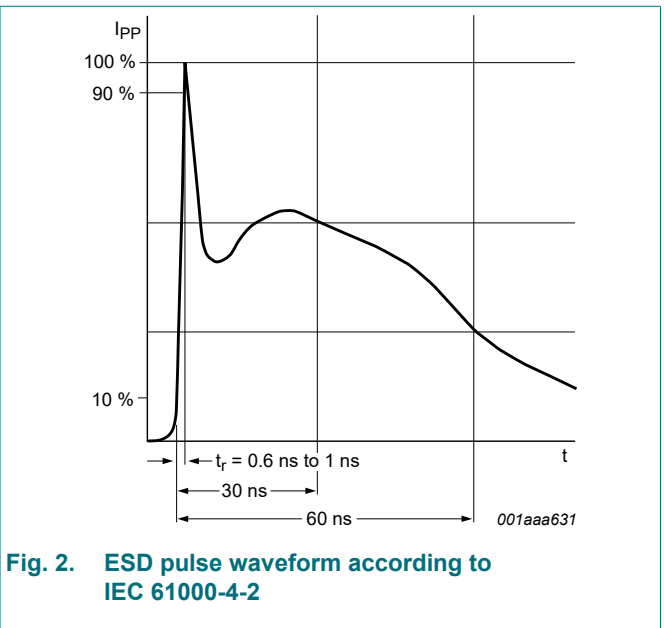
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
$I_{PPM}$	rated peak pulse current	$t_p = 8/20 \mu s$	[1] [2]	-	1.8	A
$T_j$	junction temperature			-	150	°C
$T_{amb}$	ambient temperature			-55	150	°C
$T_{stg}$	storage temperature			-65	150	°C
<b>ESD maximum ratings</b>						
$V_{ESD}$	electrostatic discharge voltage	IEC 61000-4-2; contact discharge	[2] [3]	-	15	kV
		ISO 10605; contact discharge; C = 330 pF, R = 330 $\Omega$	[2] [3]	-	12	kV
		ISO 10605; contact discharge; C = 150 pF, R = 330 $\Omega$	[2] [3]	-	15	kV

- [1] According to IEC 61000-4-5.
- [2] Measured from pin 1 or 2 to pin 3.
- [3] Device stressed with ten non-repetitive ESD pulses.



**Fig. 1. 8/20  $\mu s$  pulse waveform according to IEC 61000-4-5**



**Fig. 2. ESD pulse waveform according to IEC 61000-4-2**

### 9. Characteristics

Table 6. Characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$V_{RWM}$	reverse standoff voltage	$T_{amb} = 25\text{ }^{\circ}\text{C}$		-	-	27	V
$V_{BR}$	breakdown voltage	$I_R = 10\text{ mA}; T_{amb} = 25\text{ }^{\circ}\text{C}$	[1]	28	-	38	V
$I_{RM}$	reverse leakage current	$V_{RWM} = 27\text{ V}; T_{amb} = 25\text{ }^{\circ}\text{C}$	[1]	-	1	50	nA
$C_d$	diode capacitance	$f = 1\text{ MHz}; V_R = 2.5\text{ V}; T_{amb} = 25\text{ }^{\circ}\text{C}$	[1]	-	3.6	4	pF
		$f = 1\text{ MHz}; V_R = -2.5\text{ V}; T_{amb} = 25\text{ }^{\circ}\text{C}$	[1]	-	3.6	4	pF
$\Delta C_d/C_d$	diode capacitance matching	$f = 1\text{ MHz}; V_R = 2.5\text{ V}; T_{amb} = 25\text{ }^{\circ}\text{C}$	[2]	-	0.5	-	%
		$f = 1\text{ MHz}; V_R = -2.5\text{ V}; T_{amb} = 25\text{ }^{\circ}\text{C}$	[2]	-	0.5	-	%
$V_{CL}$	clamping voltage	$I_{PPM} = 1\text{ A}; t_p = 8/20\text{ }\mu\text{s}; T_{amb} = 25\text{ }^{\circ}\text{C}$	[3] [1]	-	34	45	V
$R_{dyn}$	dynamic resistance	$I_R = 10\text{ A}; T_{amb} = 25\text{ }^{\circ}\text{C}$	[4] [1]	-	1.3	-	$\Omega$

- [1] Measured from pin 1 or 2 to pin 3.
- [2]  $\Delta C_d$  is the difference of the capacitance measured between pin 1 and pin 3 and the capacitance measured between pin 2 and pin 3.
- [3] Device stressed with 8/20  $\mu\text{s}$  exponential decay waveform according to IEC 61000-4-5.
- [4] Non-repetitive current pulse, Transmission Line Pulse (TLP); square pulse; ANSI / ESD STM5.5.1-2008

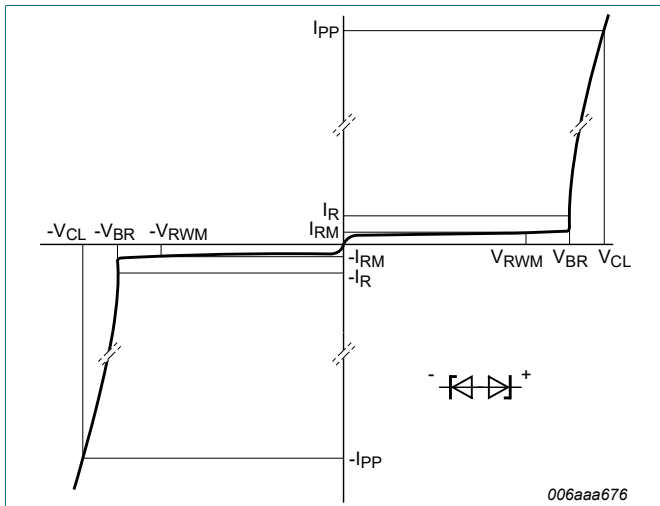


Fig. 3. V-I characteristics for a bidirectional ESD protection diode

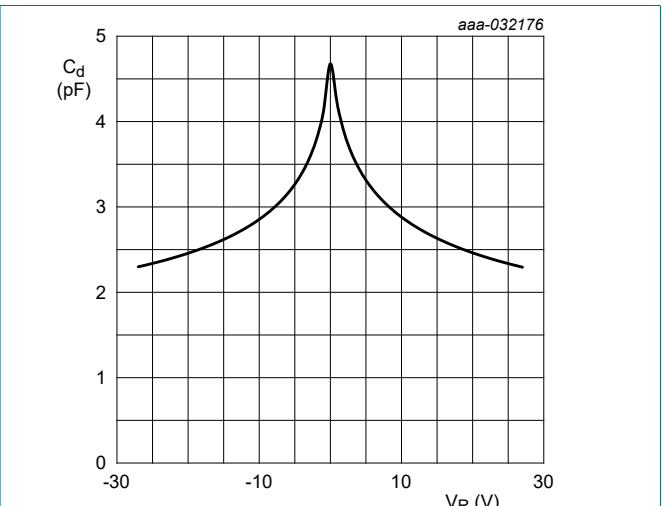
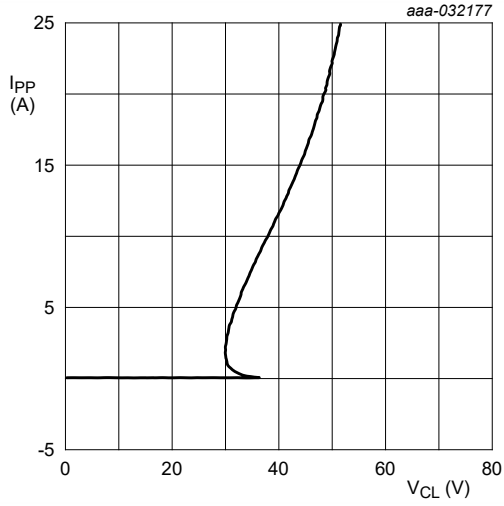
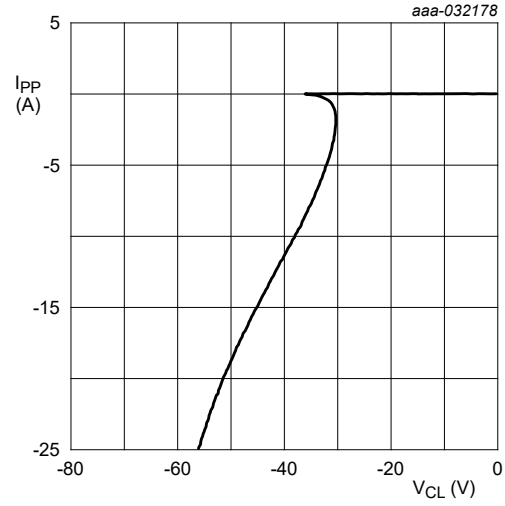


Fig. 4. Diode capacitance as a function of reverse voltage; typical values



$t_p = 100$  ns; Transmission Line Pulse (TLP)

Fig. 5. Positive clamping voltage (TLP); typical values



$t_p = 100$  ns; Transmission Line Pulse (TLP)

Fig. 6. Negative clamping voltage (TLP); typical values

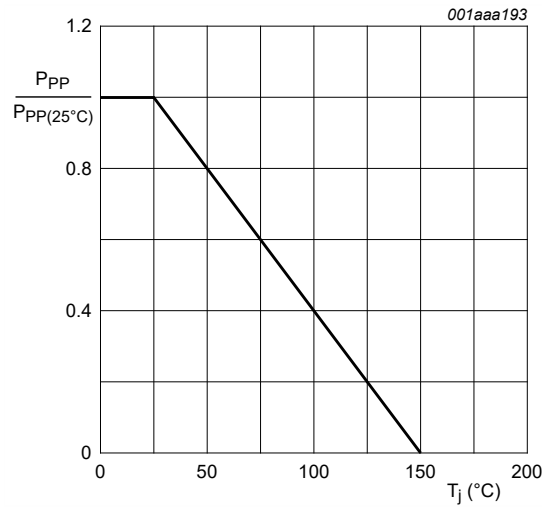


Fig. 7. Relative variation of peak pulse power as a function of junction temperature; typical values

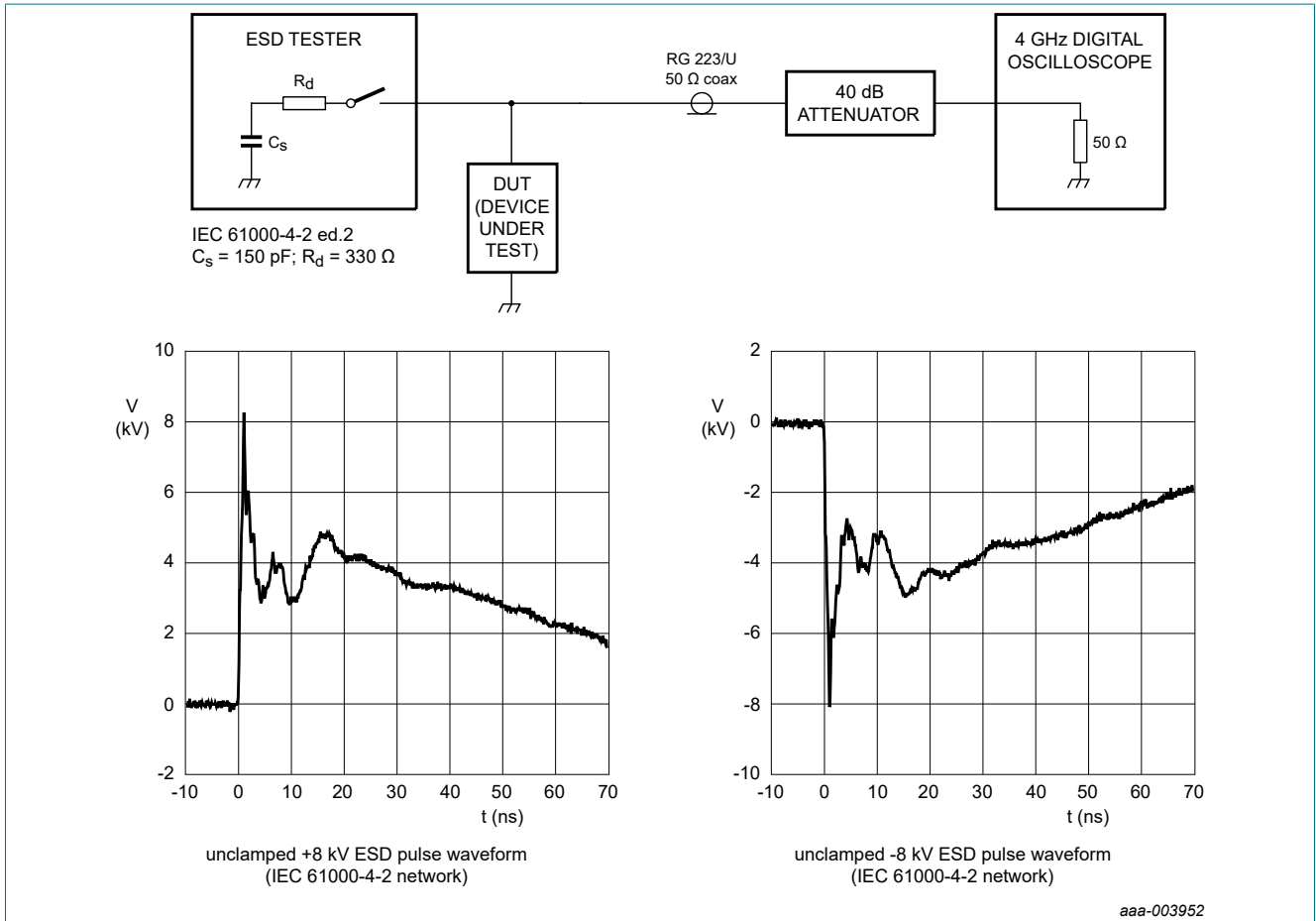


Fig. 8. ESD clamping test setup and waveforms

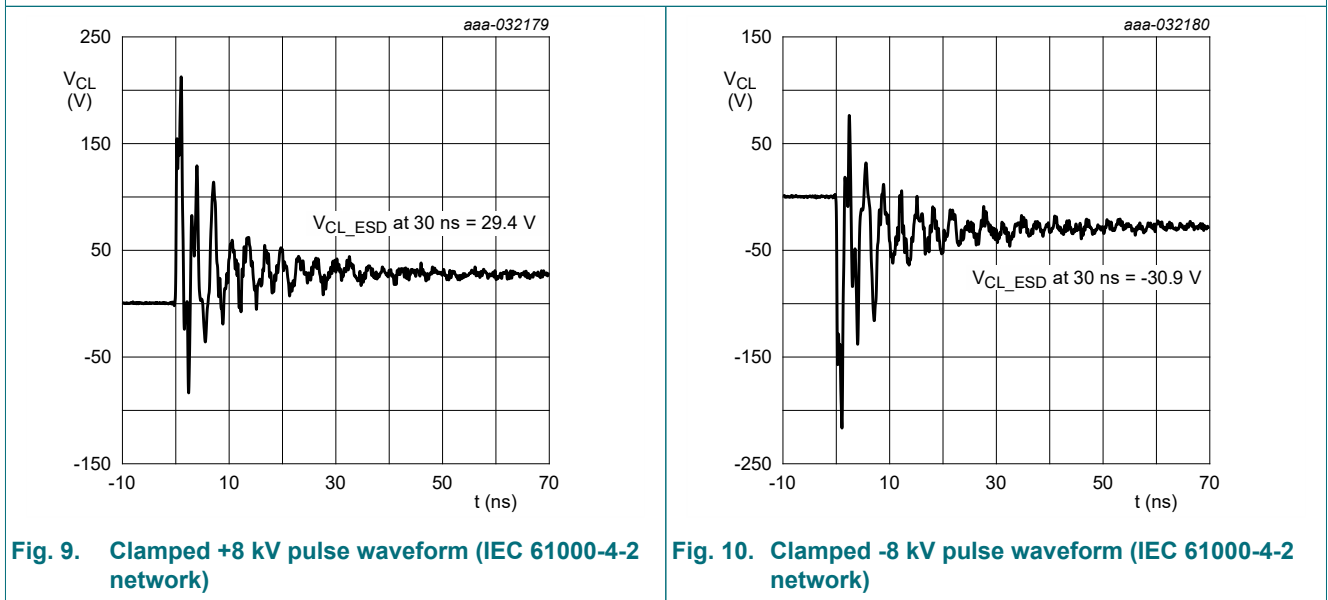


Fig. 9. Clamped +8 kV pulse waveform (IEC 61000-4-2 network)

Fig. 10. Clamped -8 kV pulse waveform (IEC 61000-4-2 network)

## 10. Application information

The device is designed for the protection of two automotive in-vehicle bus lines, e.g. CAN (FD), from the damage caused by ESD and surge pulses.

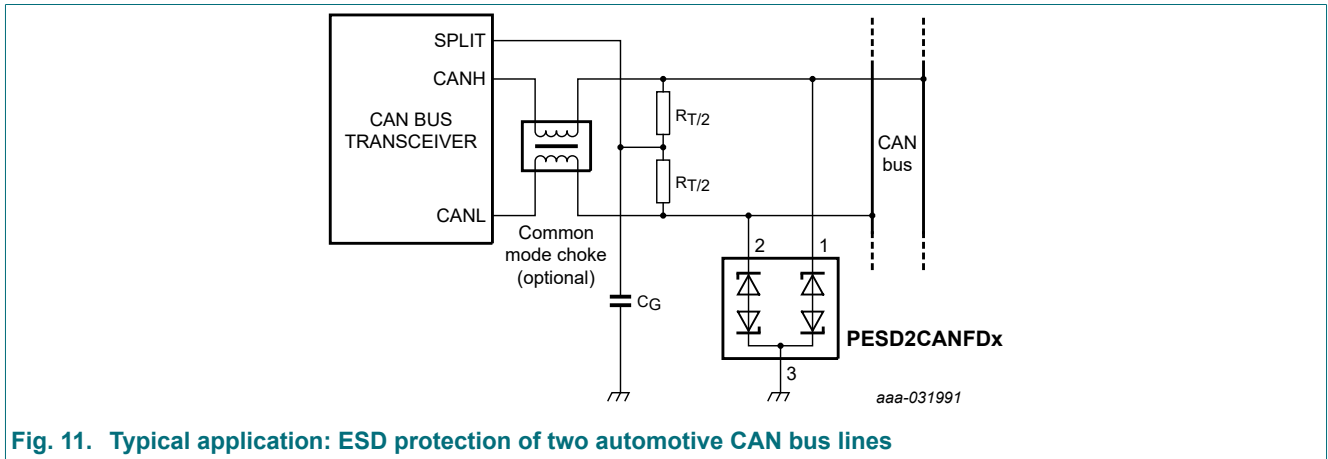


Fig. 11. Typical application: ESD protection of two automotive CAN bus lines

### Circuit board layout and protection device placement

Circuit board layout is critical for the suppression of ESD, Electrical Fast Transient (EFT) and surge transients. The following guidelines are recommended:

1. Place the device as close to the input terminal or connector as possible.
2. Minimize the path length between the device and the protected line.
3. Keep parallel signal paths to a minimum.
4. Avoid running protected conductors in parallel with unprotected conductors.
5. Minimize all Printed-Circuit Board (PCB) conductive loops including power and ground loops.
6. Minimize the length of the transient return path to ground.
7. Avoid using shared transient return paths to a common ground point.
8. Use ground planes whenever possible. For multilayer PCBs, use ground vias.

## 11. Test information

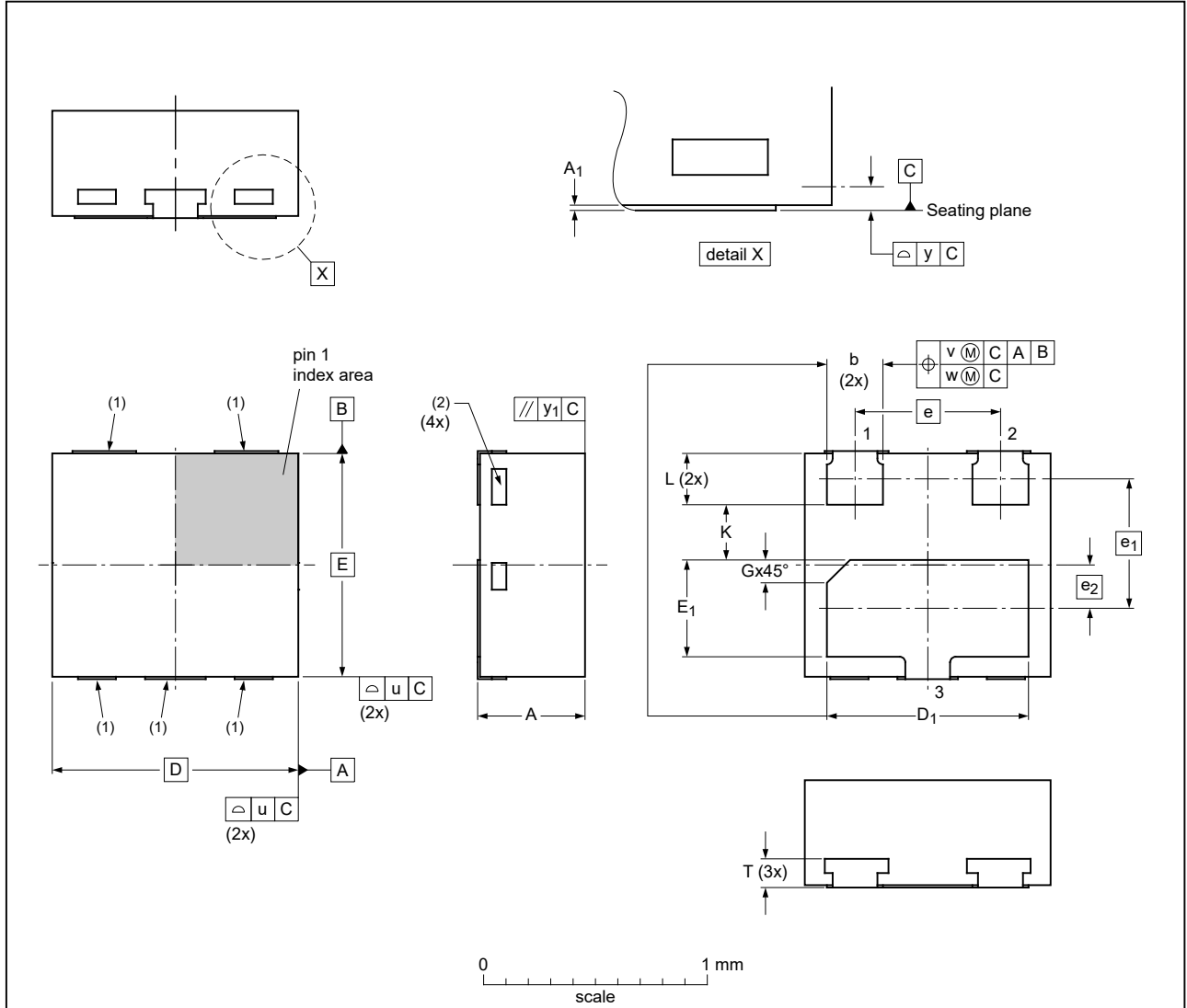
### Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

## 12. Package outline

DFN1110D-3: plastic, leadless extremely thin small outline package with side-wettable flanks (SWF); 3 terminals; 0.65 mm pitch; 1.1 mm x 1 mm x 0.48 mm body

SOT8015



Dimensions (mm are the original dimensions)

Unit	A	A <sub>1</sub>	b	D	D <sub>1</sub>	E	E <sub>1</sub>	e	e <sub>1</sub>	e <sub>2</sub>	G	K	L	T	u	v	w	y	y <sub>1</sub>
max	0.50	0.040	0.30		0.95		0.48						0.27	0.22					
nom	0.47	0.020	0.25	1.1	0.90	1	0.43	0.65	0.58	0.19	0.09		0.23	0.16	0.05	0.1	0.05	0.05	0.05
min	0.44	0.005	0.22		0.87		0.40				(ref)	0.2	0.20	0.10					

Note

- Side Wettable Flank, protrusion max. 0.02 mm.
  - Visible depend upon used manufacturing technology.
- Dimension A and T are including plating thickness.

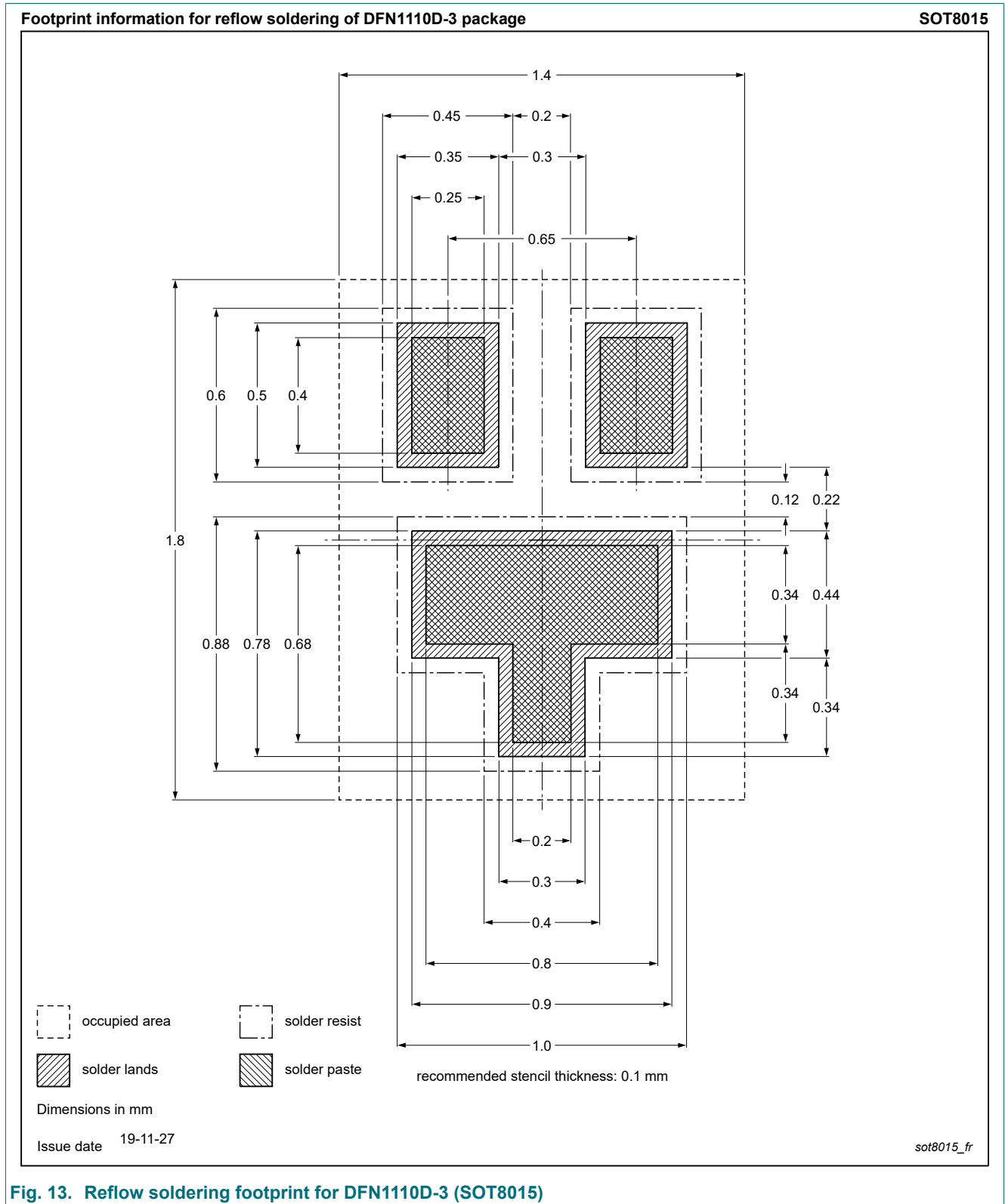
sot8015\_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT8015		MO-340BA				19-12-02 19-12-04

Fig. 12. Package outline DFN1110D-3 (SOT8015)



### 13. Soldering



**Fig. 13. Reflow soldering footprint for DFN1110D-3 (SOT8015)**

## 14. Revision history

Table 7. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PESD2CANFD27U-QB v.1	20200930	Product data sheet	-	-

## 15. Legal information

### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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